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 Change in menu Project

Change in menu Project										
Designator		Value	Description	PackageReference		Manufacturer	Alternate PartNumber	Alternate Manufacturer		
!PCB C1, C2, C19, C20, C33, C34,	9	330uF	Printed Circuit Board CAP ALUM 330UF 35V 20% SMD	SMT Radial G	XX#### EEE-FP1V331AP	Any Panasonic	-	-		
C50, C51, C62										
C3, C4, C5, C6, C21, C22, C23, C24, C35, C36, C37, C38, C52, C53, C54,	16	4.7uF	CAP, CERM, 4.7uF, 50V, +/-10%, X7R, 1206	1206	GRM31CR71H475KA12 L	MuRata		-		
C55 C7, C25, C39, C56	4	10uF	CAP, CERM, 10uF, 35V, +/-10%, X7R, 1210	1210	GRM32ER7YA106KA12	MuRata	-	-		
C8, C10, C26, C28, C40, C43, C57, C59	8	0.47uF	CAP, CERM, 0.47uF, 25V, +/-10%, X7R, 0603	0603	GRM188R71E474KA12 D	MuRata	-	-		
C9, C16, C27, C41, C58	5	100pF	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	0603	GRM1885C1H101JA01 D	MuRata	-	-		
C11, C29, C44, C60	4	1uF	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0603	0603	GRM188R71E105KA12 D		-	-		
C12, C30, C45, C46	4	470pF	CAP, CERM, 470pF, 100V, +/-5%, C0G/NP0, 0805	0805	D	MuRata	-	-		
C13, C31, C47, C49	1	0.1uF	CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0603 CAP, CERM, 0.047uF, 25V, +/-10%, X7R, 0603	0603	GRM188R71E104KA01 D		-	-		
C14	4	0.047uF 100pF	CAP, CERM, 0.047uF, 25V, +/-10%, X/R, 0603	0603	GRM188R71E473KA01 D C0603C101J5GAC		-	-		
C48, C61		·	•			Kemet	-	-		
C18 C32	1	4700pF 2.2uF	CAP, CERM, 4700pF, 25V, +/-5%, C0G/NP0, 0603 CAP, CERM, 2.2uF, 16V, +/-10%, X5R, 0603	0603 0603	C1608C0G1E472J GRM188R61C225KE15 D		-	-		
C42	1	220pF	CAP, CERM, 220pF, 50V, +/-5%, C0G/NP0, 0603	0603	C1608C0G1H221J	TDK	-	-		
Cinx D1, D2, D3,	4	1.8mF 0.57V	CAP, Aluminum Electrolytic, 1.8 mF, 16V, TH Diode, Schottky, 60V, 1A, SOD-123F	SOD-123F	PMEG6010CEH,115	SUNCON NXP Semiconductor	-	-		
D5 FID1, FID2,	3		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A				
FID3 H1, H2, H3,	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips	Screw	NY PMS 440 0025 PH	B&F Fastener Supply	-	-		
H4 H5, H6, H7,	4		panhead Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone	-	-		
IN1, OUT1,	6	White	Test Point, TH, Compact, White	Keystone5007	5007	Keystone	-	-		
Sync In 1, Sync In 2, Sync In 3, Sync In 4										
J1, J2 J3, J4, J5,	4	50A	Terminal 50A Lug Standard Banana Jack, Uninsulated, 8.9mm	CB35-36-CY Keystone575-8	CB35-36-CY 575-8	Panduit Keystone	-	-		
J6 L1, L2, L3,	4	1.3 uH	Inductor, Flat Wire, 1.3uH, 34.5A, 0.94 mOhm, SMT	-	7443556130	Wurth Elektronik	-	-		
L4 LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200"	PCB Label 0.650"H x	THT-14-423-10	Brady	-	-		
Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8	8	40V	H - 10,000 per roll MOSFET, N-CH, 30V, 100A, SON 5x6mm	0.200"W SON 5x6mm	CSD18501Q5A	Texas Instruments	-	-		
R1, R1a, R1b, R20, R20a, R20b, R31, R31a, R31b, R44, R44a, R44b	12	0.005	RES, 0.005 ohm, 5%, 2W, 0830	0830	RL7520WT-R005-J	Susumu		-		
R2, R4, R5, R9, R10, R21, R22, R23, R27, R28, R32, R33, R34, R39, R41, R45, R46, R47, R51,	20	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	ERJ-3GEY0R00V	Panasonic	-			
R6 R7, R25,	4	49.9k 3.3	RES, 49.9k ohm, 1%, 0.1W, 0603 RES, 3.3 ohm, 5%, 0.1W, 0603	0603 0603	CRCW060349K9FKEA CRCW06033R30JNEA	Vishay-Dale Vishay-Dale	-	-		
R36, R49 R8 R11, R29,	1 4	11.3k 33.2k	RES, 11.3k ohm, 1%, 0.1W, 0603 RES, 33.2k ohm, 1%, 0.1W, 0603	0603 0603	CRCW060311K3FKEA CRCW060333K2FKEA	Vishay-Dale Vishay-Dale				
R42, R53 R12, R24, R30, R38,	6	10.0k	RES, 10.0k ohm, 1%, 0.1W, 0603	0603		Vishay-Dale Vishay-Dale	-	-		
R43, R54 R15	1	121k	RES, 121k ohm, 1%, 0.1W, 0603	0603	CRCW0603121KFKEA	Vishay-Dale	-	-		
R16	1	5.76k	RES, 5.76k ohm, 1%, 0.1W, 0603	0603	CRCW06035K76FKEA	Vishay-Dale				
R17 R18	1	49.9k 604	RES, 49.9k ohm, 1%, 0.125W, 0805 RES, 604 ohm, 1%, 0.125W, 0805	0805 0805	ERJ-6ENF4992V CRCW0805604RFKEA	Panasonic Vishay-Dale	-	-		
R26	1	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale	-	-		
R35 R37	1 1	18.0k 402	RES, 18.0k ohm, 0.1%, 0.1W, 0603 RES, 402 ohm, 1%, 0.1W, 0603	0603 0603	RT0603BRD0718KL CRCW0603402RFKEA	Yageo America Vishay-Dale	-	-		
R40	1	1.50k	RES, 1.50k ohm, 1%, 0.1W, 0603	0603	CRCW06031K50FKEA	Vishay-Dale	-	-		
R48, R50, R55, R56	1	7.5	RESISTOR 7.5 OHM 3/4W 5% 2010	2010	ERJ-12ZYJ7R5U CRCW0603158KFKEA	Panasonic	-	-		
R58 SW1, SW2, SW3, SW4	4	158k White	RES, 158k ohm, 1%, 0.1W, 0603 Test Point, TH, Miniature, White	0603 Keystone5002	5002	Vishay-Dale Keystone	-	-		

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
U1, U3, U4,	4			eg: 0603, used in	LM5122MH	TI	-	-
U7				PnP report				
U5	1		IC OSC MONO TIMING 3MHZ 8-SOIC		LMC555CMX	National Semiconductor		
U6	1		IC 10-OUT DECADE COUNTER 16-SOIC	D (R-PDSO-G16)	CD4017BM96			
U8	1		Series of Adjustable Micropower Voltage Regulators, 8-	SDC08A	LP2951CSD	National Semiconductor		
			pin LLP					
Vin Gnd,	2	Black	Test Point, TH, Miniature, Black	Keystone5001	5001	Keystone	-	-
Vout Gnd						-		
Vin, Vout	2	Red	Test Point, TH, Miniature, Red	Keystone5000	5000	Keystone	-	-
R57	0	100k	RES, 100k ohm, 1%, 0.1W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale	-	-

Notes

Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

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